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(54) **ACOUSTIC RESONATOR STRUCTURE HAVING AN ELECTRODE WITH A CANTILEVERED PORTION**

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(51) **Int. Cl.**

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**H03H 9/02** (2006.01)  
**H03H 9/13** (2006.01)  
**H03H 9/54** (2006.01)  
**H03H 9/70** (2006.01)

(52) **U.S. Cl.**

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USPC ..... 333/187, 189  
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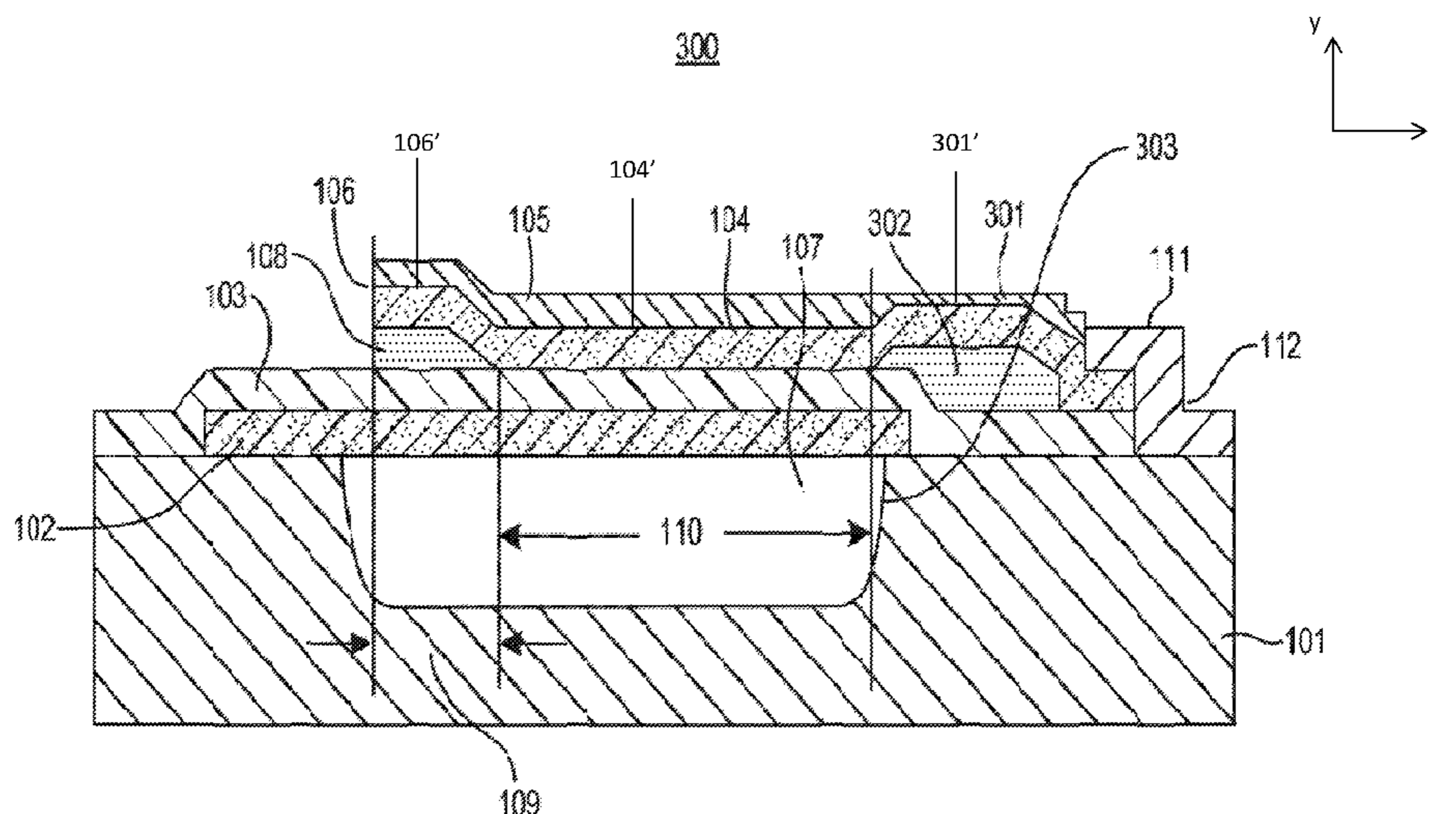
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Primary Examiner — Barbara Summons

(57) **ABSTRACT**

An acoustic resonator comprises a first electrode and second electrode comprising a plurality of sides. At least one of the sides of the second electrode comprises a cantilevered portion. A piezoelectric layer is disposed between the first and second electrodes. A bridge disposed adjacent to one of the sides of the second electrode.

**20 Claims, 14 Drawing Sheets**



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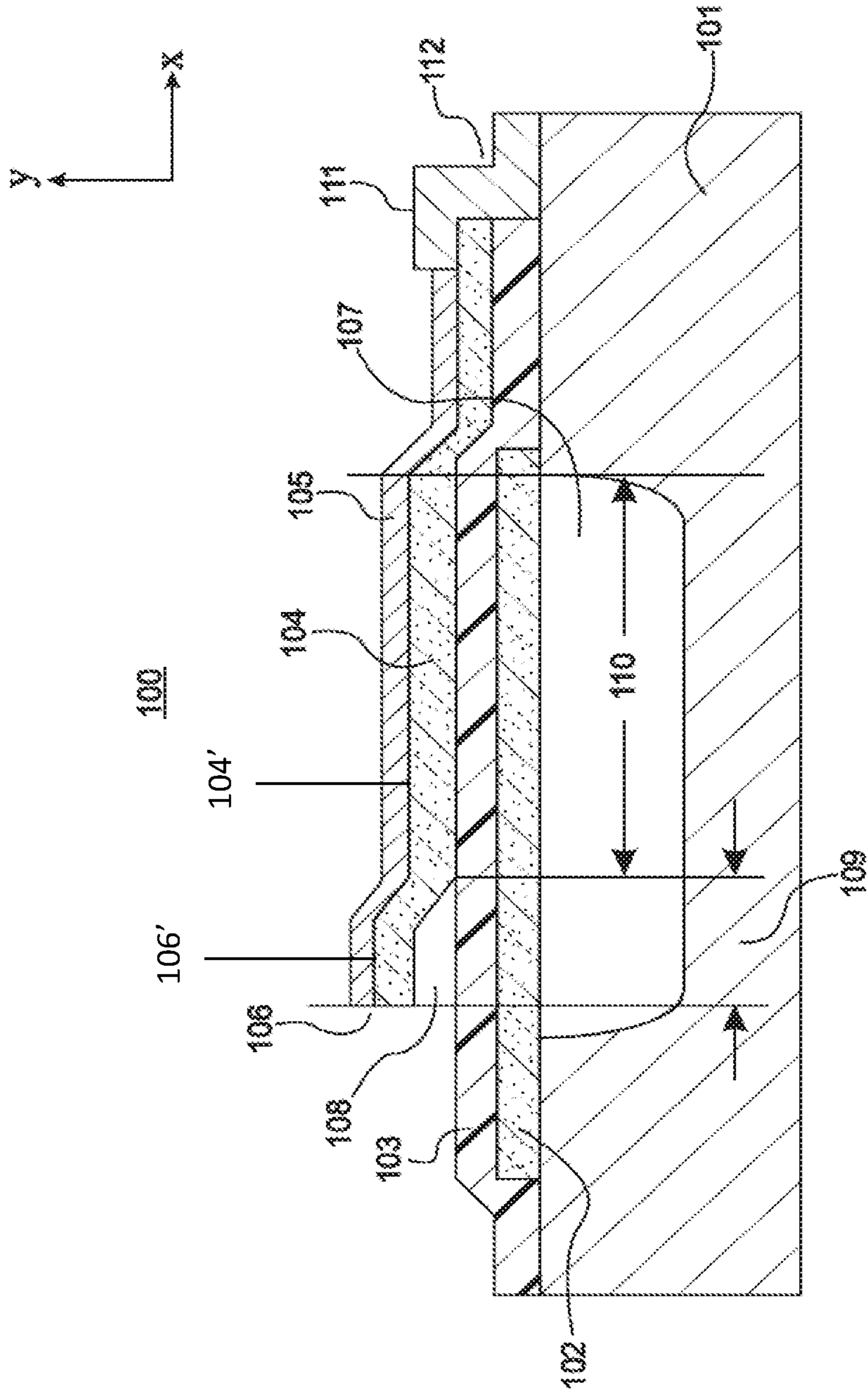


FIG. 1A

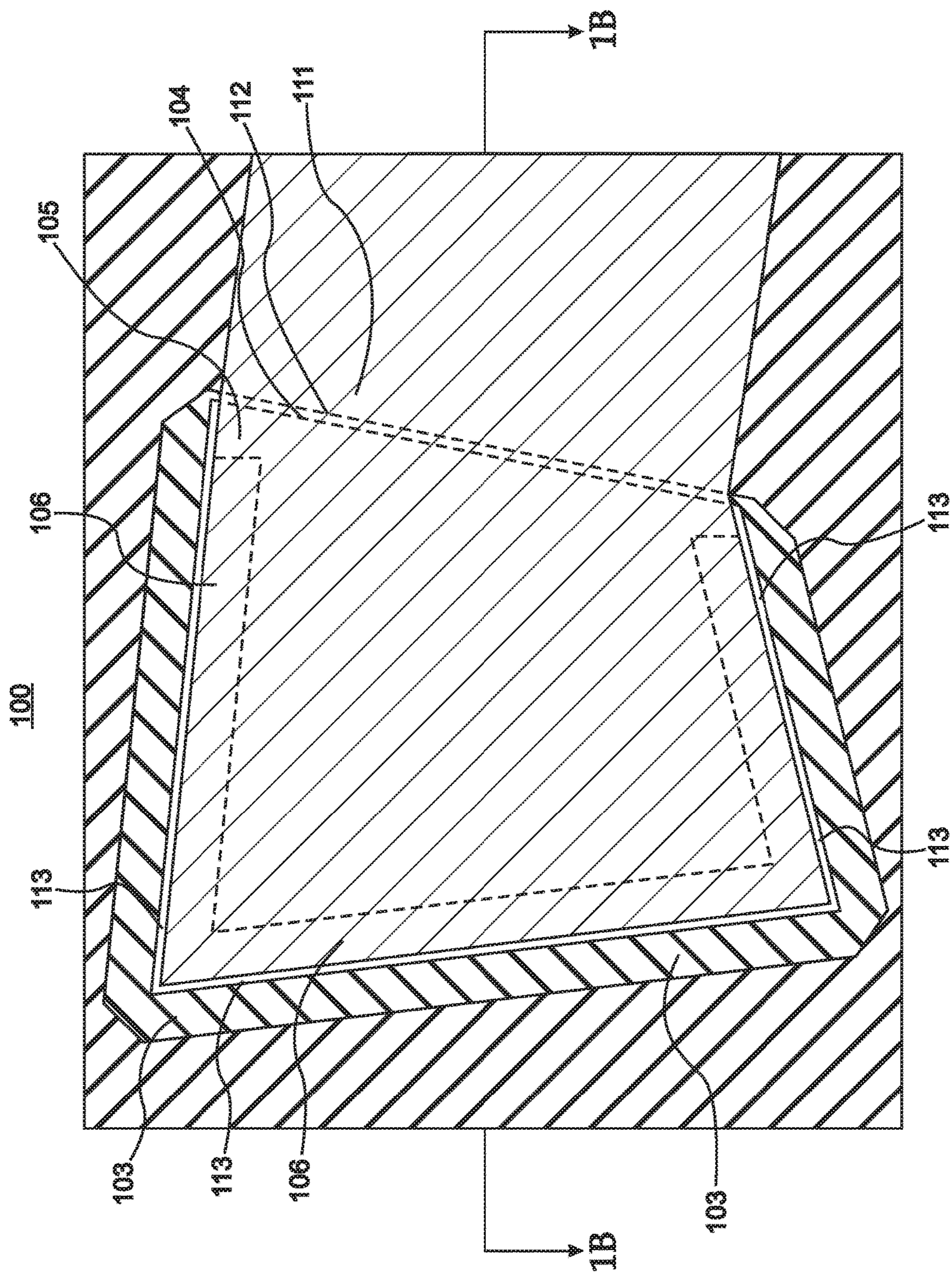


FIG. 1B

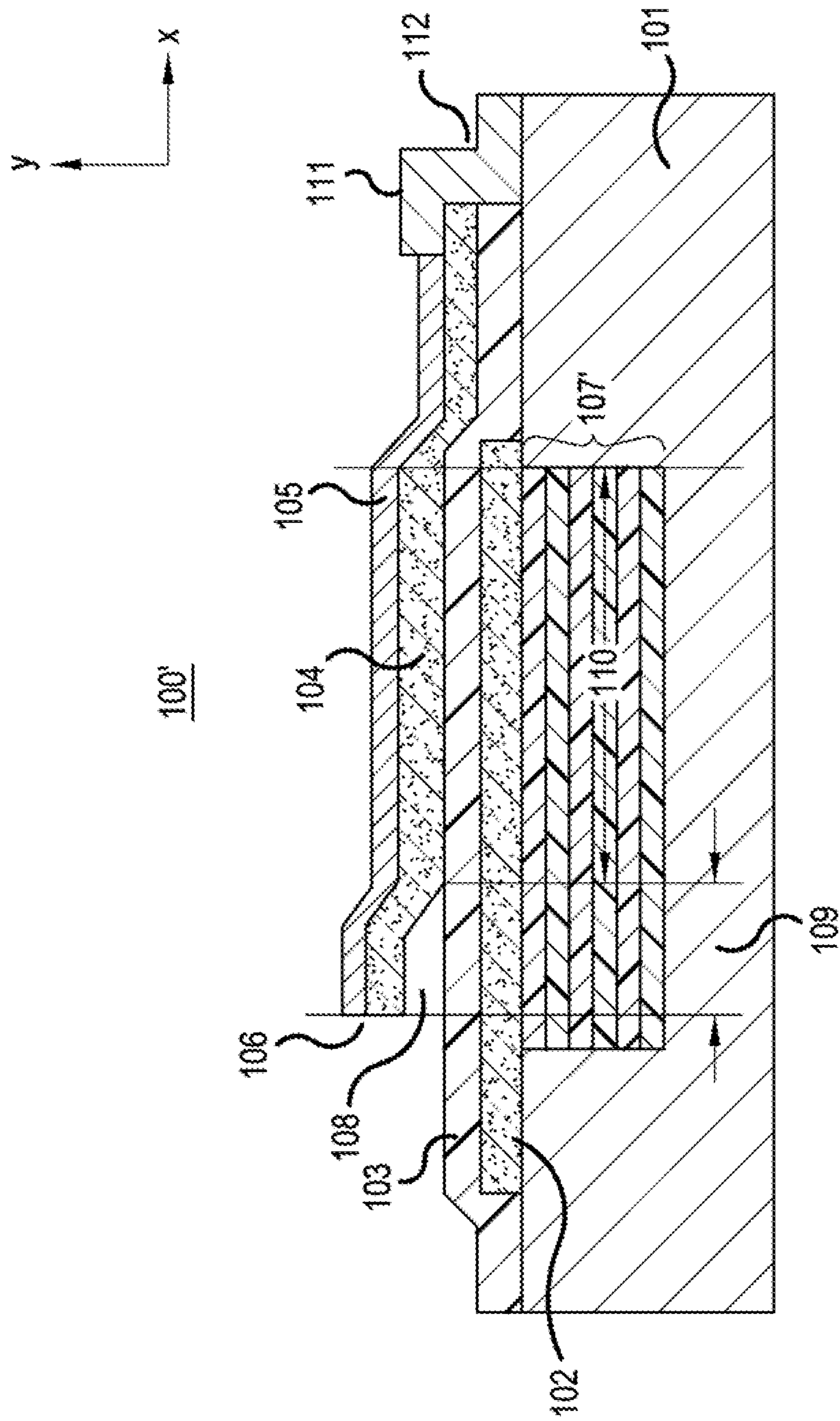


FIG.1C

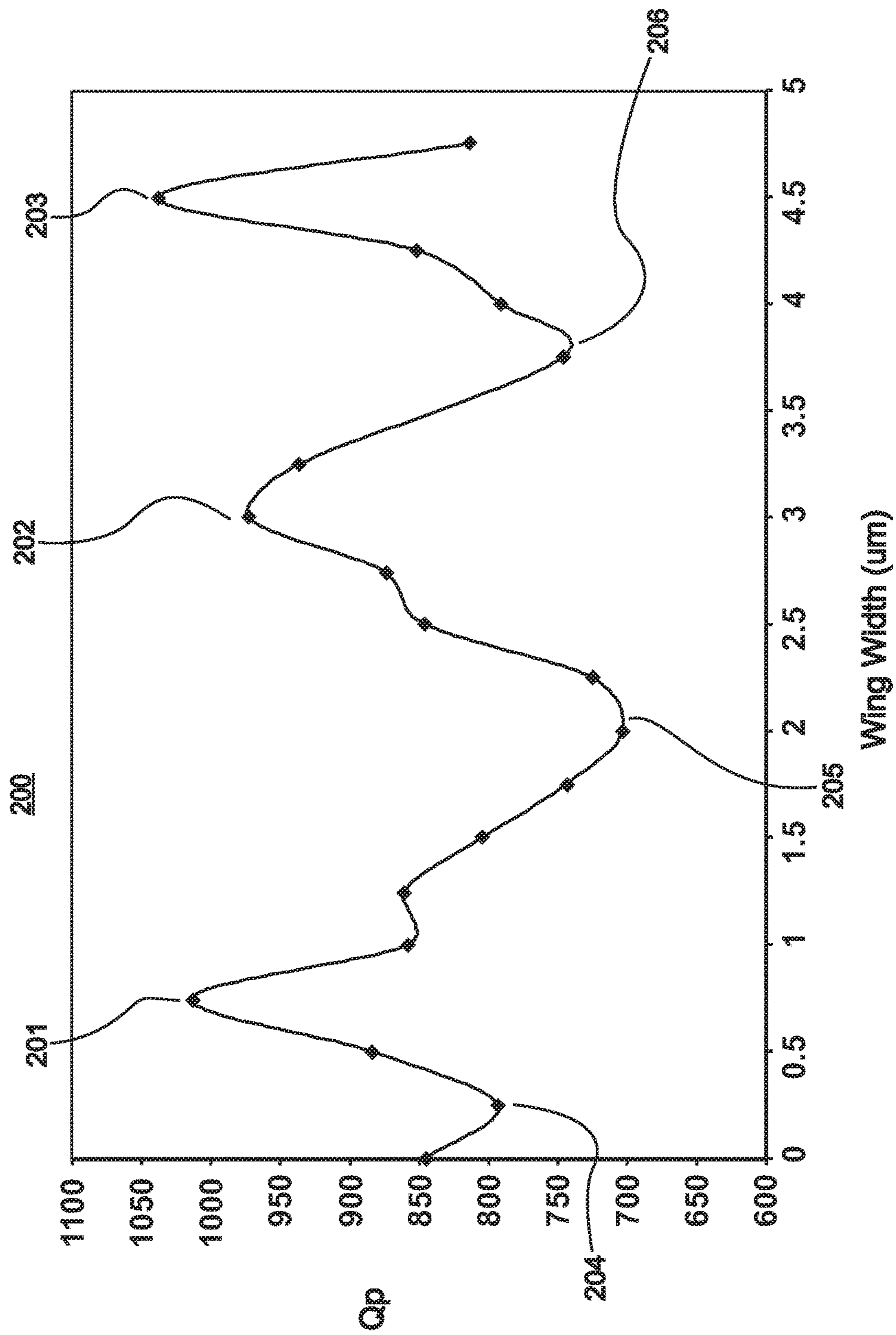


FIG. 2A

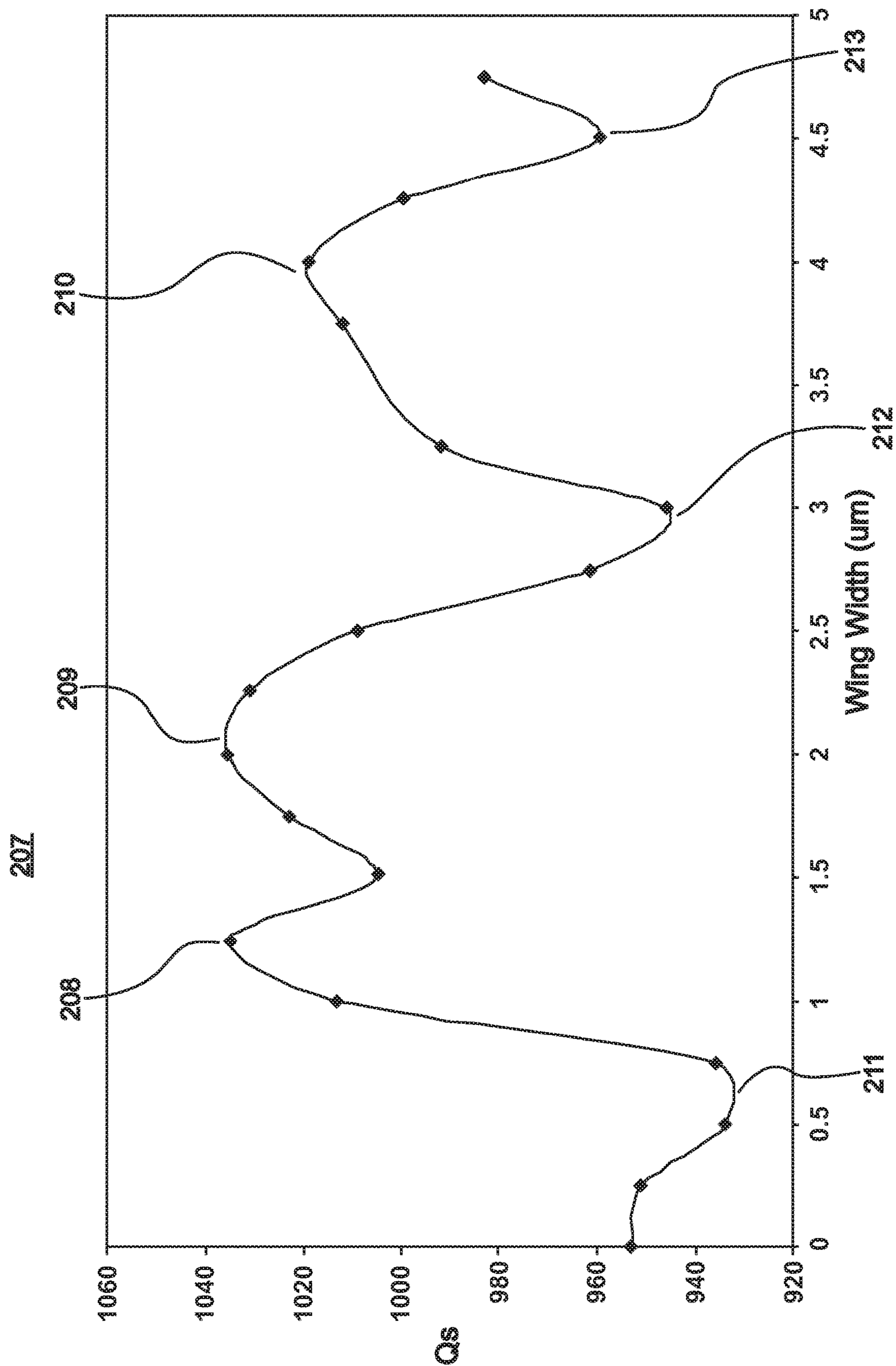


FIG. 2B





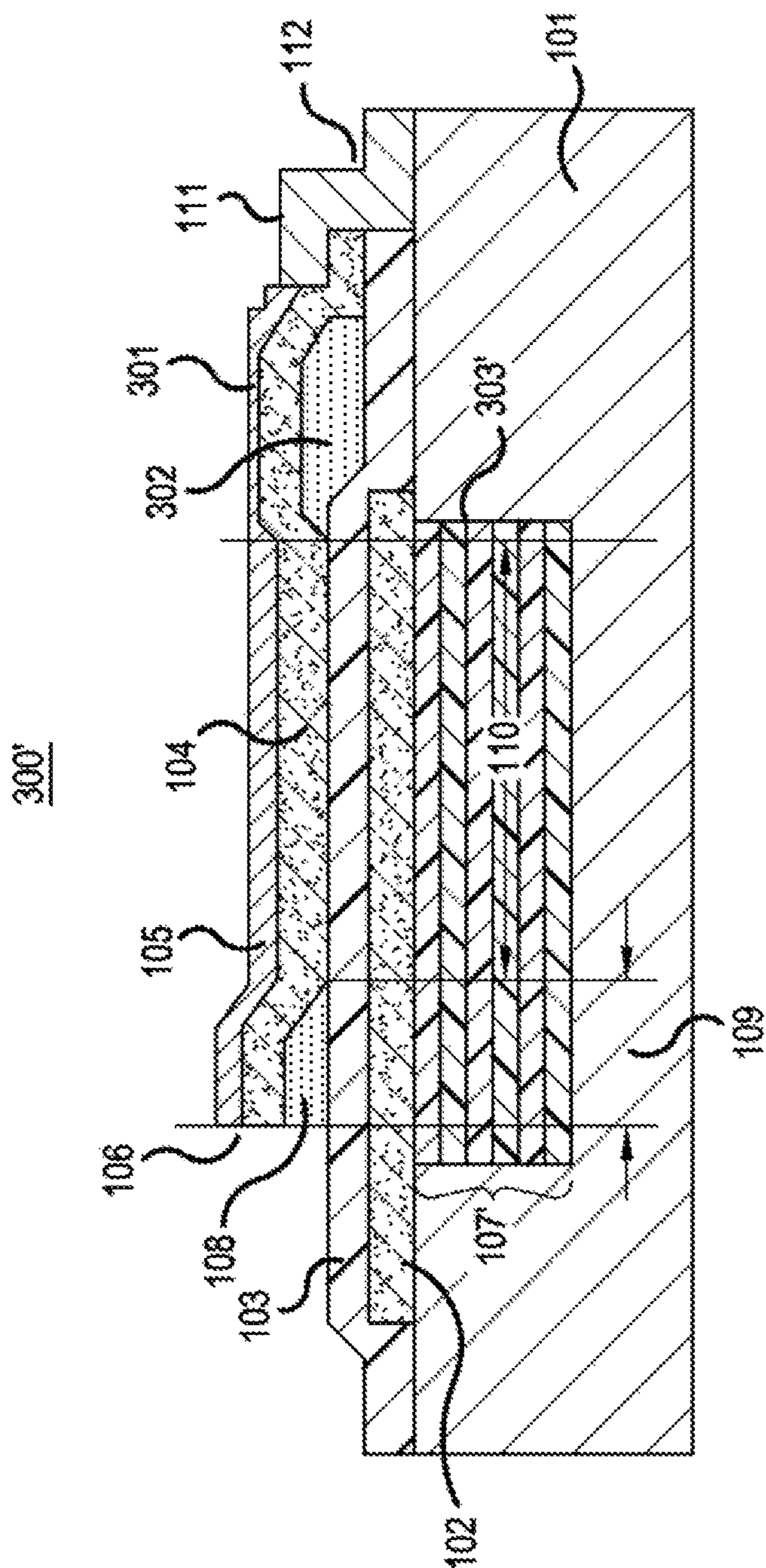


FIG.3B

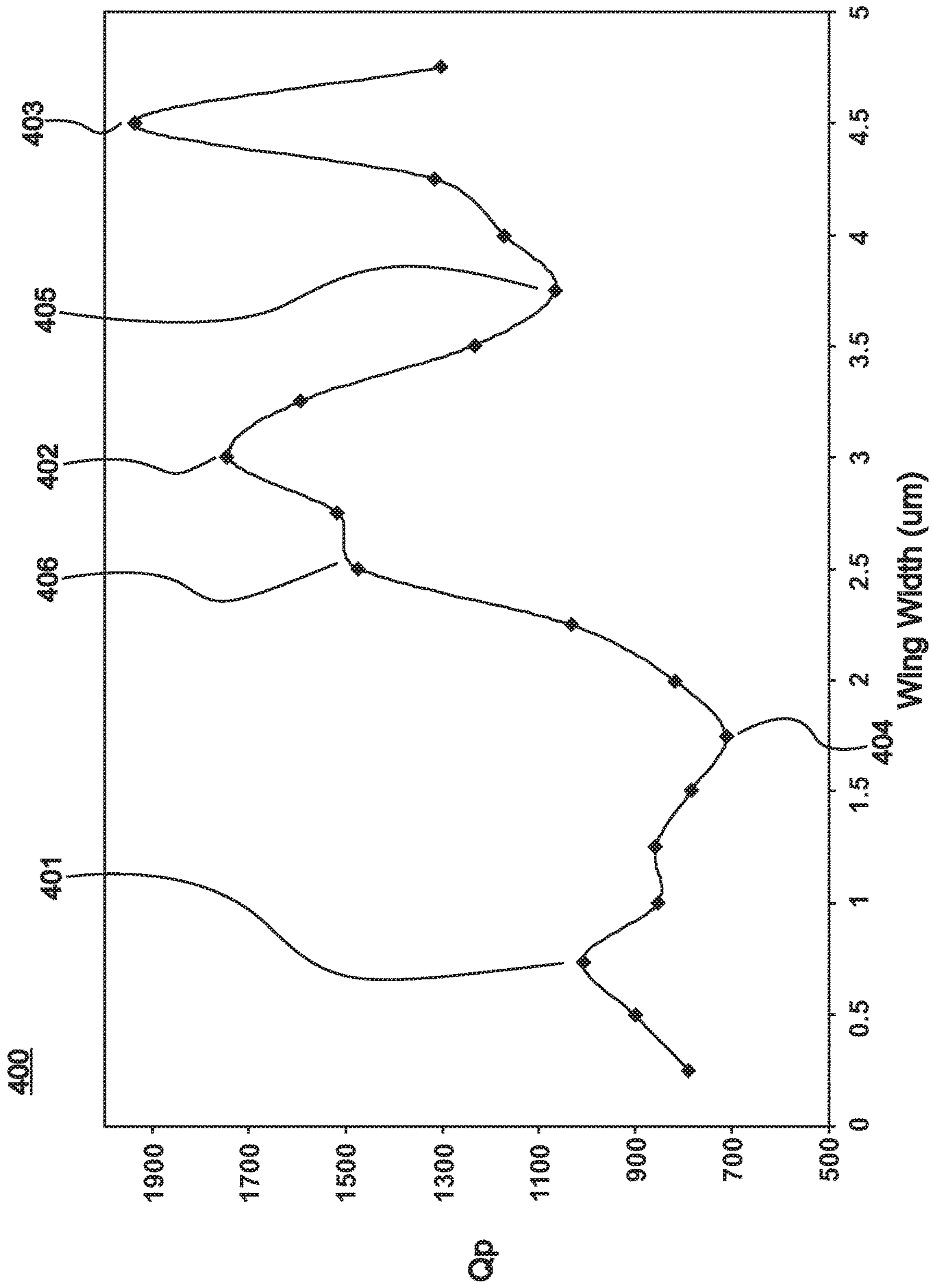


FIG. 4A

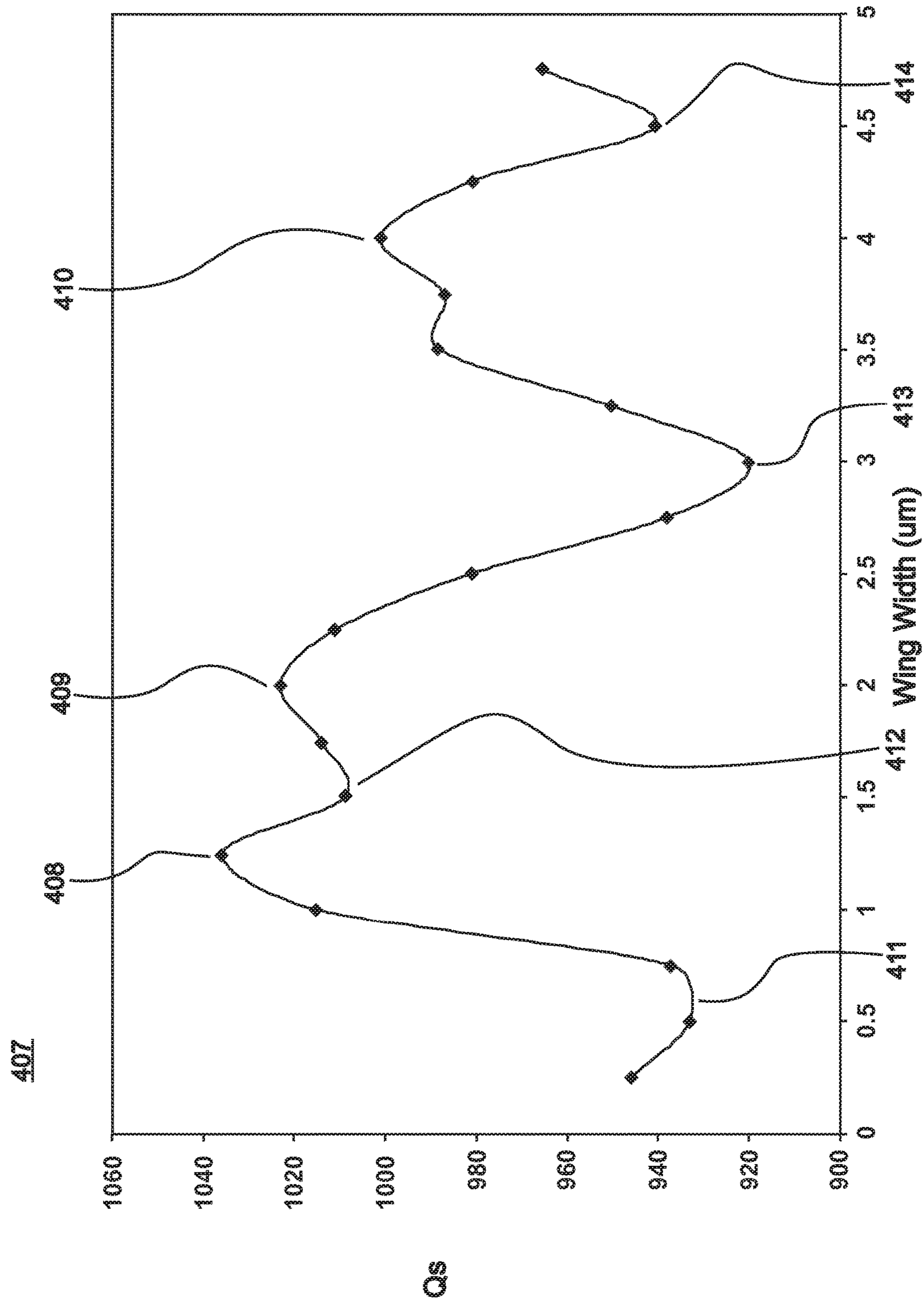


FIG. 4B

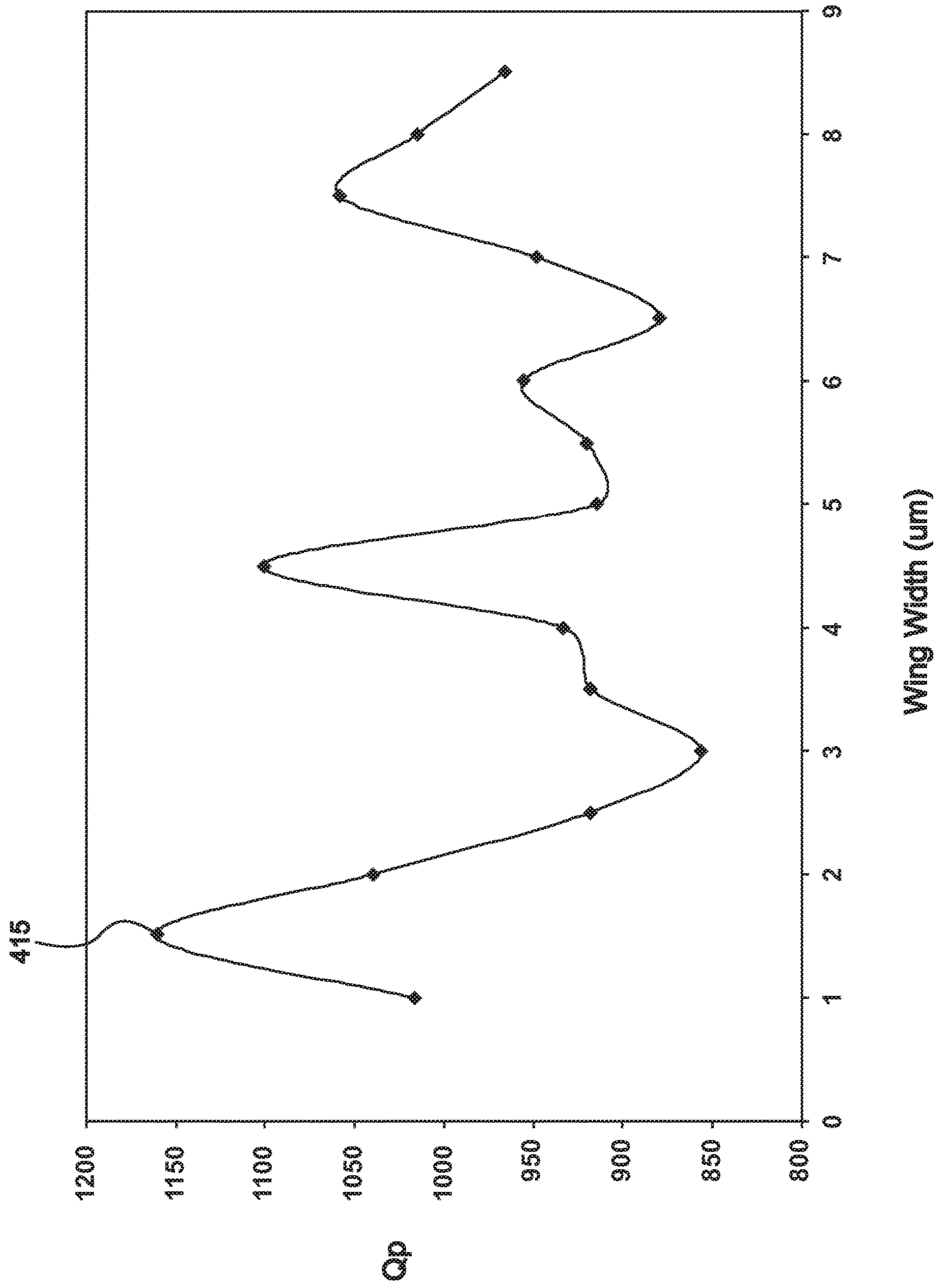


FIG. 4C

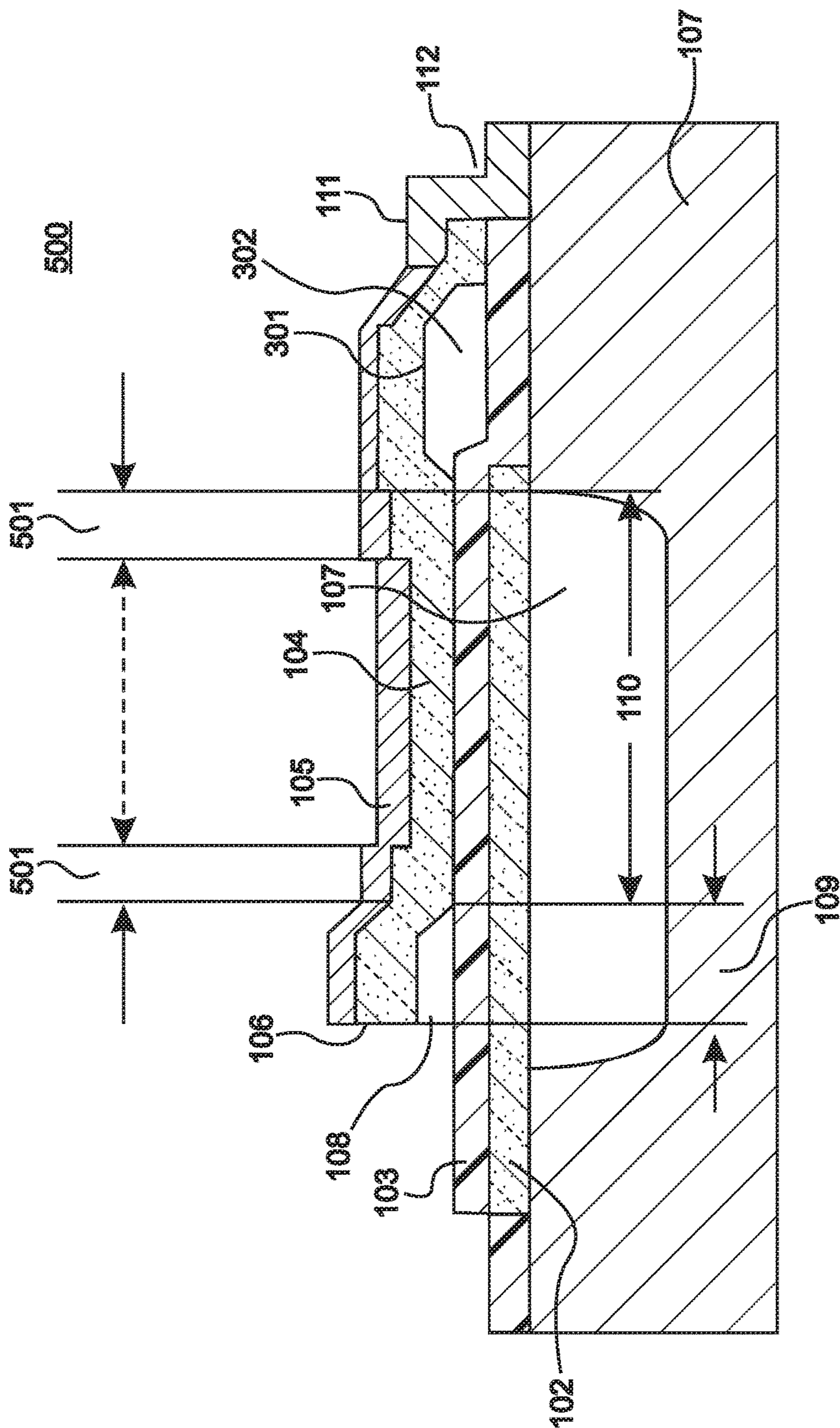


FIG. 5A

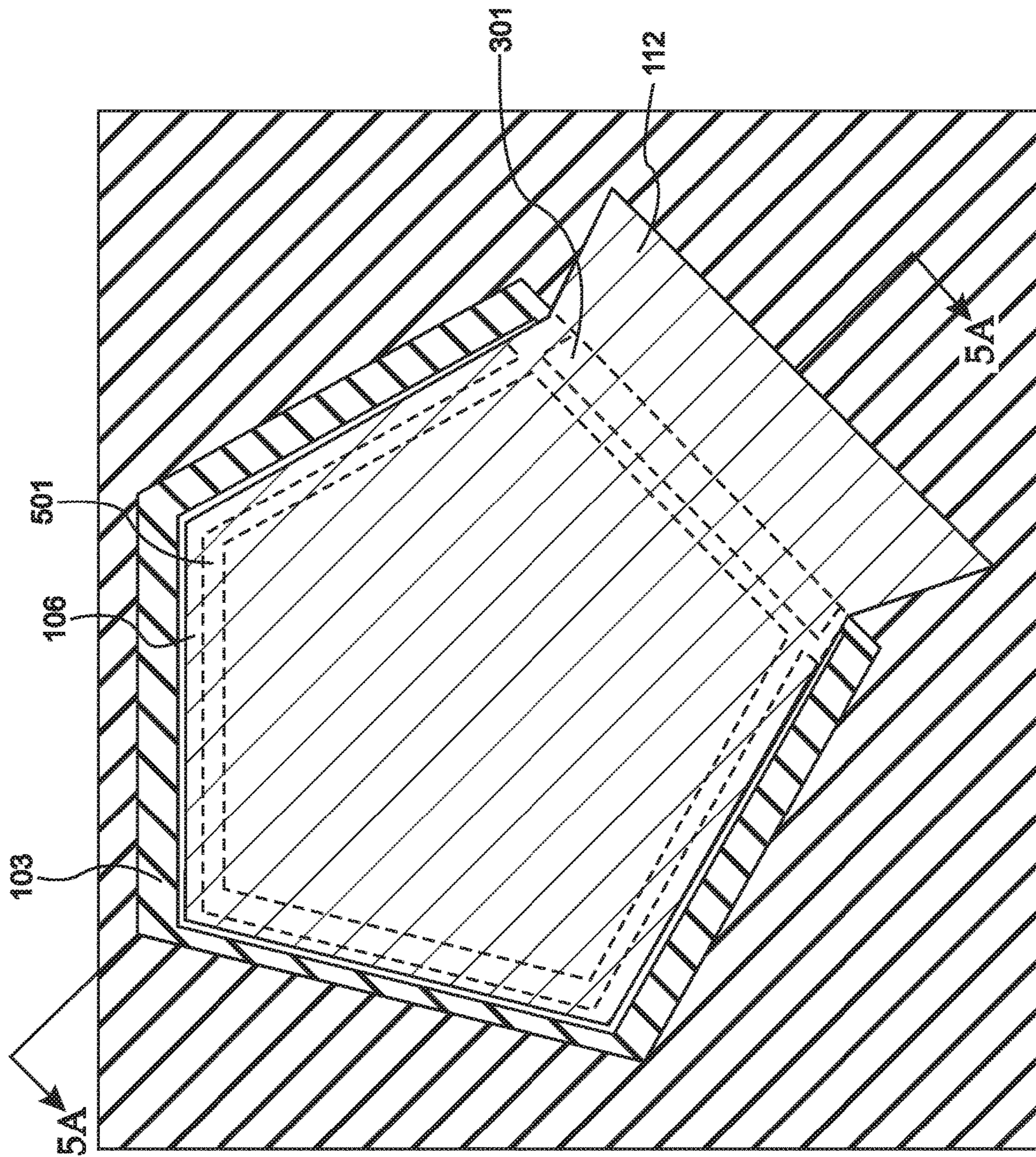


FIG. 5B

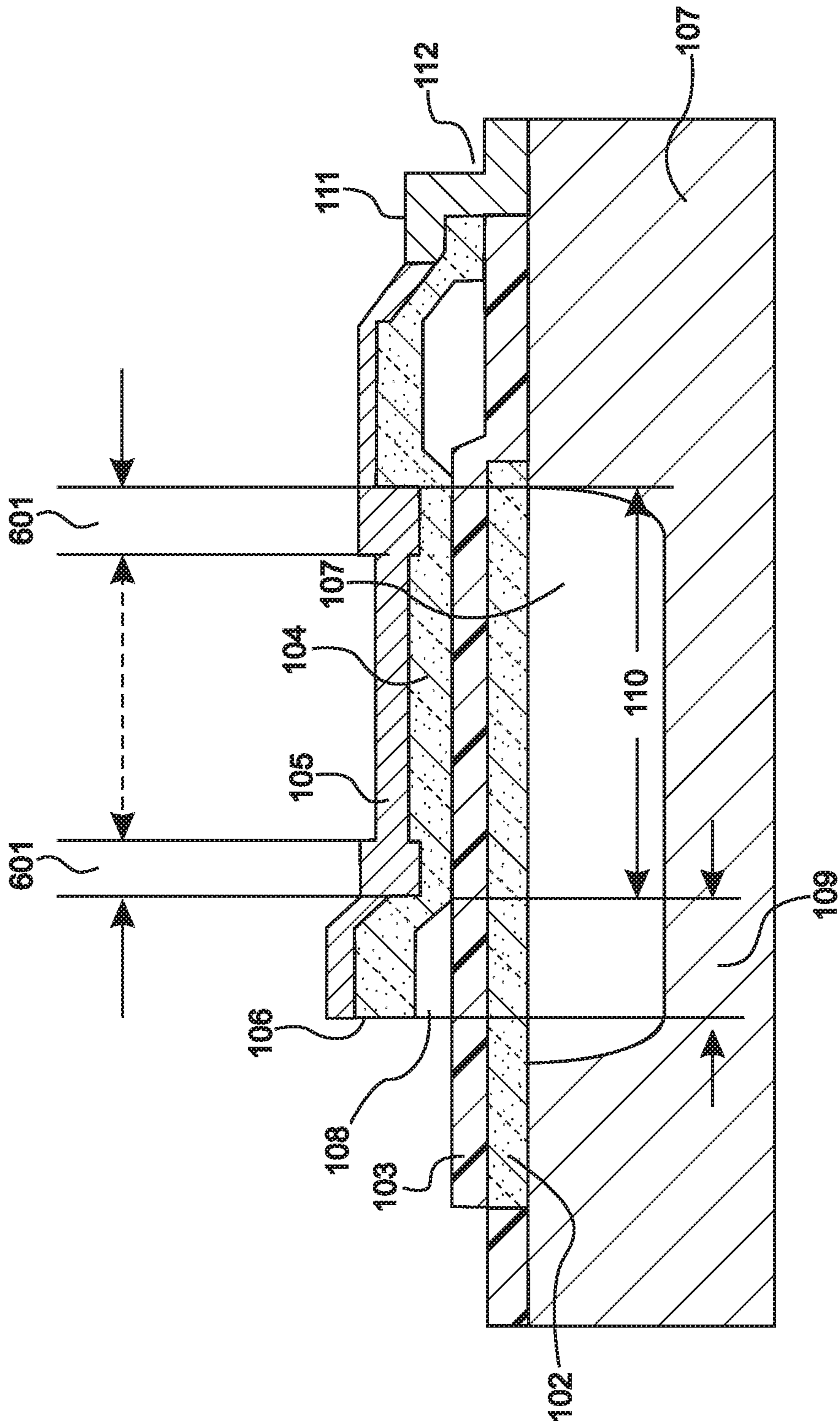


FIG. 6

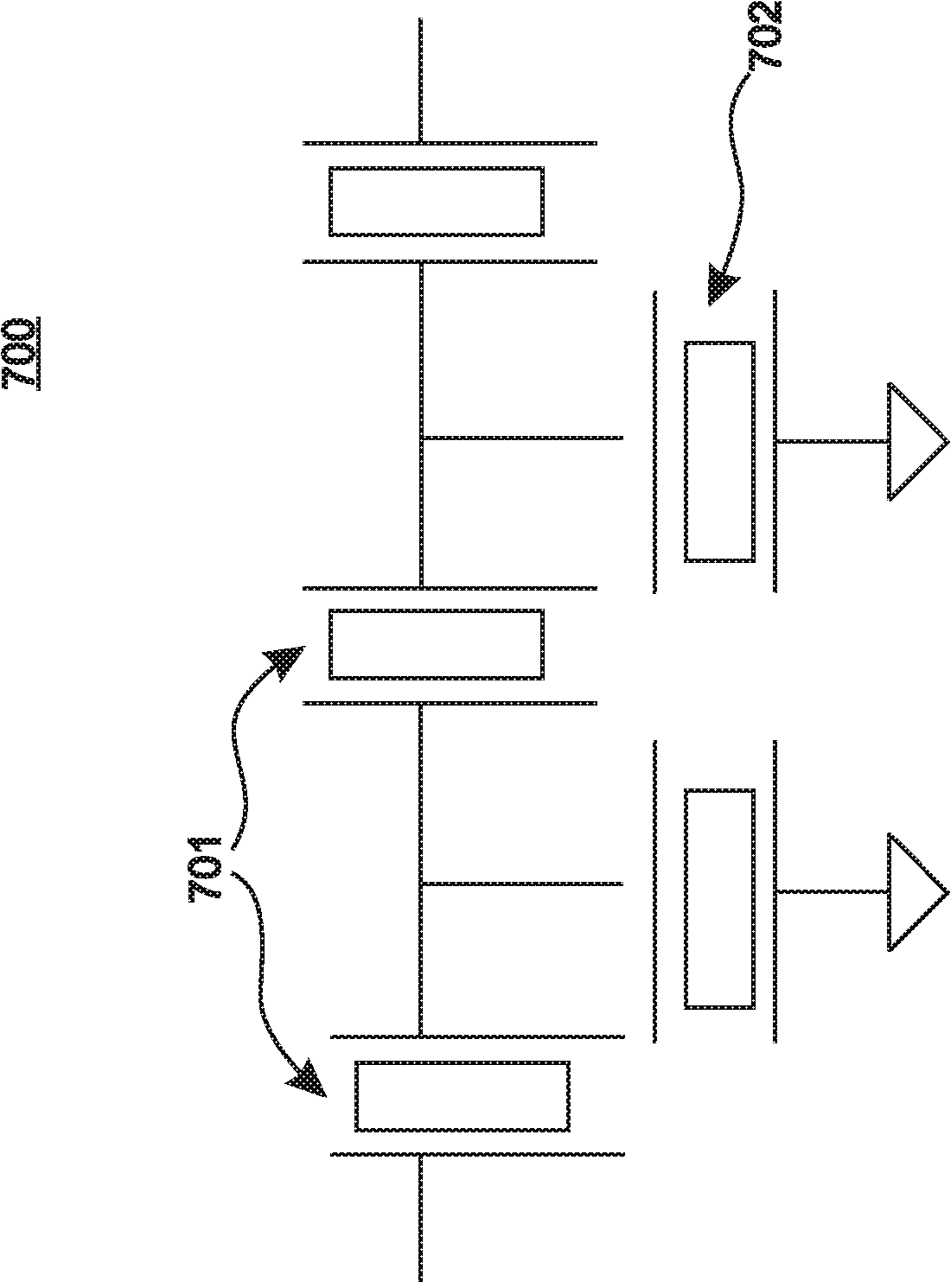


FIG. 7



**ACOUSTIC RESONATOR STRUCTURE  
HAVING AN ELECTRODE WITH A  
CANTILEVERED PORTION**

CROSS-REFERENCE TO RELATED  
APPLICATIONS

The present application is a continuation of and claims priority under 35 U.S.C. § 120 from U.S. patent application Ser. No. 14/165,301 (now U.S. Pat. No. 9,520,856) to John Choy, et al. and filed on Jan. 27, 2014, which is a continuation of and claims priority under 35 U.S.C. § 120 from U.S. patent application Ser. No. 12/626,035 to John Choy, et al, and filed on Nov. 25, 2009 (now U.S. Pat. No. 8,902,023). The entire disclosures of the parent patent applications and of the parent patents are specifically incorporated herein by reference.

BACKGROUND

In many electronic applications, electrical resonators are used. For example, in many wireless communications devices, radio frequency (rf) and microwave frequency resonators are used as filters to improve reception and transmission of signals. Filters typically include inductors and capacitors, and more recently resonators.

As will be appreciated, it is desirable to reduce the size of components of electronic devices. Many known filter technologies present a barrier to overall system miniaturization. With the need to reduce component size, a class of resonators based on the piezoelectric effect has emerged. In piezoelectric-based resonators, acoustic resonant modes are generated in the piezoelectric material. These acoustic waves are converted into electrical waves for use in electrical applications.

One type of piezoelectric resonator is a Film Bulk Acoustic Resonator (FBAR). The FBAR has the advantage of small size and lends itself to Integrated Circuit (IC) manufacturing tools and techniques. The FBAR includes an acoustic stack comprising, inter alia, a layer of piezoelectric material disposed between two electrodes. Acoustic waves achieve resonance across the acoustic stack, with the resonant frequency of the waves being determined by the materials in the acoustic stack.

FBARs are similar in principle to bulk acoustic resonators such as quartz, but are scaled down to resonate at GHz frequencies. Because the FBARs have thicknesses on the order of microns and length and width dimensions of hundreds of microns, FBARs beneficially provide a comparatively compact alternative to known resonators.

Desirably, the bulk acoustic resonator excites only thickness-extensional (TE) modes, which are longitudinal mechanical waves having propagation (k) vectors in the direction of propagation. The TE modes desirably travel in the direction of the thickness (e.g., z-direction) of the piezoelectric layer.

Unfortunately, in addition to the desired TE modes there are lateral modes, known as Rayleigh-Lamb modes, generated in the acoustic stack as well. The Rayleigh-Lamb modes are mechanical waves having k-vectors that are perpendicular to the direction of TE modes, the desired modes of operation. These lateral modes travel in the areal dimensions (x, y directions of the present example) of the piezoelectric material. Among other adverse effects, lateral modes deleteriously impact the quality (Q) factor of an FBAR device. In particular, the energy of Rayleigh-Lamb modes is lost at the interfaces of the FBAR device. As will

be appreciated, this loss of energy to spurious modes is a loss in energy of desired longitudinal modes, and ultimately a degradation of the Q-factor.

What is needed, therefore, is an acoustic resonator that overcomes at least the known shortcomings described above.

BRIEF DESCRIPTION OF THE DRAWINGS

The illustrative embodiments are best understood from the following detailed description when read with the accompanying drawing figures. It is emphasized that the various features are not necessarily drawn to scale. In fact, the dimensions may be arbitrarily increased or decreased for clarity of discussion. Wherever applicable and practical, like reference numerals refer to like elements.

FIG. 1A shows a cross-sectional view of an acoustic resonator in accordance with a representative embodiment.

FIG. 1B shows a top view of an acoustic resonator in accordance with a representative embodiment.

FIG. 1C shows a cross-sectional view of an acoustic resonator in accordance with a representative embodiment.

FIG. 2A shows a graph of the Q-factor at parallel resonance ( $Q_p$ ) versus width of the cantilevered portion(s) of an acoustic resonator in accordance with a representative embodiment.

FIG. 2B shows a graph of the Q-factor at series resonance ( $Q_s$ ) versus width of the cantilevered portion(s) of an acoustic resonator in accordance with a representative embodiment.

FIG. 3A shows a cross-sectional view of an acoustic resonator in accordance with a representative embodiment.

FIG. 3B shows a cross-sectional view of an acoustic resonator in accordance with a representative embodiment.

FIG. 4A shows a graph of the Q-factor at parallel resonance ( $Q_p$ ) versus width of the cantilevered portion(s) of an acoustic resonator in accordance with a representative embodiment.

FIG. 4B shows a graph of the Q-factor at series resonance ( $Q_s$ ) versus width of the cantilevered portion(s) of an acoustic resonator in accordance with a representative embodiment.

FIG. 4C shows a graph of the Q-factor at parallel resonance ( $Q_p$ ) versus width of the cantilevered portion(s) of an acoustic resonator in accordance with a representative embodiment.

FIG. 5A shows a cross-sectional view of an acoustic resonator in accordance with a representative embodiment taken along line 5A-5A in FIG. 5B.

FIG. 5B shows a top view of an acoustic resonator in accordance with a representative embodiment.

FIG. 6 shows a cross-sectional view of an acoustic resonator in accordance with a representative embodiment.

FIG. 7 shows a simplified schematic diagram of an electrical filter in accordance with a representative embodiment.

DEFINED TERMINOLOGY

It is to be understood that the terminology used herein is for purposes of describing particular embodiments only, and is not intended to be limiting. The defined terms are in addition to the technical and scientific meanings of the defined terms as commonly understood and accepted in the technical field of the present teachings.

As used in the specification and appended claims, the terms 'a', 'an' and 'the' include both singular and plural

referents, unless the context clearly dictates otherwise. Thus, for example, ‘a device’ includes one device and plural devices.

As used in the specification and appended claims, and in addition to their ordinary meanings, the terms ‘substantial’ or ‘substantially’ mean to with acceptable limits or degree. For example, ‘substantially cancelled’ means that one skilled in the art would consider the cancellation to be acceptable.

As used in the specification and the appended claims and in addition to its ordinary meaning, the term ‘approximately’ means to within an acceptable limit or amount to one having ordinary skill in the art. For example, ‘approximately the same’ means that one of ordinary skill in the art would consider the items being compared to be the same.

### DETAILED DESCRIPTION

In the following detailed description, for purposes of explanation and not limitation, specific details are set forth in order to provide a thorough understanding of illustrative embodiments according to the present teachings. However, it will be apparent to one having ordinary skill in the art having had the benefit of the present disclosure that other embodiments according to the present teachings that depart from the specific details disclosed herein remain within the scope of the appended claims. Moreover, descriptions of well-known apparatuses and methods may be omitted so as to not obscure the description of the illustrative embodiments. Such methods and apparatuses are clearly within the scope of the present teachings.

Generally, it is understood that the drawings and the various elements depicted therein are not drawn to scale. Further, relative terms, such as “above,” “below,” “top,” “bottom,” “upper” and “lower” are used to describe the various elements’ relationships to one another, as illustrated in the accompanying drawings. It is understood that these relative terms are intended to encompass different orientations of the device and/or elements in addition to the orientation depicted in the drawings. For example, if the device were inverted with respect to the view in the drawings, an element described as “above” another element, for example, would now be below that element.

FIG. 1A is a cross-sectional view along the line 1B-1B of an acoustic resonator **100** in accordance with a representative embodiment. Illustratively, the acoustic resonator **100** comprises an FBAR. The acoustic resonator **100** comprises a substrate **101**, a first electrode **102** disposed beneath a piezoelectric layer **103**, which comprises a first surface in contact with a first electrode **102** and a second surface in contact with a second electrode **104**. An optional passivation layer **105** is provided over the second electrode **104**. A cantilevered portion **106** of the second electrode **104** is provided on at least one side of the second electrode **104**. The cantilevered portion **106** may also be referred to as a ‘wing.’

As depicted in FIG. 1A, the second electrode **104** comprises a first surface **104'**. As can be seen, the first surface **104'** is disposed substantially at a first height (y-dimension in the coordinate system depicted). Similarly, the cantilevered portion **106** comprises a second surface **106'**. The second surface **106'** is disposed substantially at a second height (again, y-dimension in the coordinate system depicted). The second height is higher than the first height. Thus, the second surface **106'** is raised up relative to the first surface **104'**.

The acoustic resonator **100** may be fabricated according to known semiconductor processing methods and using known materials. Illustratively, the acoustic resonator **100** may be fabricated according to the teachings of commonly owned U.S. Pat. Nos. 5,587,620; 5,873,153; 6,384,697; 6,507,983; and 7,275,292 to Ruby, et al.; and U.S. Pat. No. 6,828,713 to Bradley, et al. The disclosures of these patents are specifically incorporated herein by reference. It is emphasized that the methods and materials described in these patents are representative and other methods of fabrication and materials within the purview of one of ordinary skill in the art are contemplated.

When connected in a selected topology, a plurality of acoustic resonators **100** can act as an electrical filter. For example, the acoustic resonators **100** may be arranged in a ladder-filter arrangement, such as described in U.S. Pat. No. 5,910,756 to Ella, and U.S. Pat. No. 6,262,637 to Bradley, et al., the disclosures of which are specifically incorporated herein by reference. The electrical filters may be used in a number of applications, such as in duplexers.

The first and second electrodes **102, 104** each comprise an electrically conductive material (e.g., molybdenum (Mo)) and provide an oscillating electric field in the y-direction of the coordinate system shown (i.e., the direction of the thickness of the substrate **101**). In the illustrative embodiment described presently, the y-axis is the axis for the TE (longitudinal) mode(s) for the resonator. In a representative embodiment, the piezoelectric layer **103** and first and second electrodes **102, 104** are suspended over a cavity **107** formed by selective etching of the substrate **101**. The cavity **107** may be formed by a number of known methods, for example as described in referenced commonly owned U.S. Pat. No. 6,384,697 to Ruby, et al. Accordingly, the acoustic resonator **100** is a mechanical resonator, which can be electrically coupled via the piezoelectric layer **103**. Other configurations that foster mechanical resonance by FBARs are contemplated. For example, the acoustic resonator **100** can be located over an acoustic mirror, such as a mismatched acoustic Bragg reflector (not shown in FIG. 1A) formed in or on the substrate **101**. FBARs provided over an acoustic mirror are sometimes referred to as solid mount resonators (SMRs) and, for example, may be as described in U.S. Pat. No. 6,107,721 to Lakin, the disclosure of which is specifically incorporated into this disclosure by reference in its entirety.

The cantilevered portion **106** of the second electrode **104** extends over a gap **108**, which illustratively comprises air. In a representative embodiment, a sacrificial layer (not shown) is deposited by known technique over the first electrode **102** and a portion of the piezoelectric layer **103**. The second electrode **104** and passivation layer **105** are provided over the sacrificial layer. Illustratively, the sacrificial material comprises phosphosilicate glass (PSG), which illustratively comprises 8% phosphorous and 92% silicon dioxide. After the formation of the second electrode **104** and passivation layer **105**, the sacrificial layer is etched away illustratively with hydrofluoric acid leaving the cantilevered portion **106**. In a representative embodiment, the sacrificial layer provided to form the cantilevered portion **106** and the sacrificial layer provided to form the cavity **107** are removed in the same process step.

Notably, rather than air, the gap **108** may comprise other materials including low acoustic impedance materials, such as carbon (C) doped SiO<sub>2</sub>, which is also referred as Black-diamond; or dielectric resin commercially known as SiLK™; or benzocyclobutene (BCB). Such low acoustic impedance materials may be provided in the gap **108** by

known methods. The low acoustic impedance material may be provided after removal of sacrificial material used to form the gap **108**, or may be used instead of the sacrificial material in the gap **108**, and not removed.

The region of contacting overlap of the first and second electrodes **102**, **104**, the piezoelectric layer **103** and the cavity **107**, or other reflector (e.g., Bragg reflector (not shown)) is referred to as an active area **110** of the acoustic resonator **100**. By contrast, an inactive area of the acoustic resonator comprises a region of overlap between first electrode **102** or second electrode **104**, or both, and the piezoelectric layer **103** not disposed over the cavity **107**, or other suspension structure, or acoustic mirror. As described more fully in the parent application, it is beneficial to the performance of the acoustic resonator **100** to reduce the area of the inactive region of the acoustic resonator **100** to the extent practical.

The cantilevered portion **106** extends beyond an edge of the active area **110** by a width **109** as shown. An electrical contact **111** is connected to a signal line (not shown) and electronic components (not shown) selected for the particular application of the acoustic resonator **100**. This portion of the acoustic resonator **100** comprises an interconnection side **112** of the acoustic resonator **100**. As will become clearer as the present description continues, the interconnection side **112** of the second electrode **104** to which the electrical contact **111** is made does not comprise a cantilevered portion. By contrast, one or more non-connecting sides of the acoustic resonator **100** may comprise cantilevered portions **106** that extend beyond the edge of the active area **110**.

FIG. **1B** shows a top view of the acoustic resonator **100** shown in cross-sectional view in FIG. **1A** and in accordance with a representative embodiment. The acoustic resonator **100** also comprises the second electrode **104** with the optional passivation layer **105** disposed thereover. The second electrode **104** of the present embodiment is illustratively apodized to reduce acoustic losses. Further details of the use of apodization in acoustic resonators may be found in commonly owned U.S. Pat. No. 6,215,375 to Larson III, et al; or in commonly owned U.S. Patent Application Publication 20070279153 entitled "Piezoelectric Resonator Structures and Electrical Filters" filed May 31, 2006, to Richard C. Ruby. The disclosures of this patent and patent application publication are specifically incorporated herein by reference in their entirety.

The second electrode **104** comprises non-connecting sides **113** and interconnection side **112**. In a representative embodiment, cantilevered portions **106** are provided along each non-contacting side **113** and have the same width. This is merely illustrative, and it is contemplated that at least one side **113**, but not all comprise a cantilevered portion **106**. Furthermore, it is contemplated that the second electrode **104** comprises more or fewer than four sides as shown. For example, a pentagonal-shaped second electrode is contemplated comprising four sides with cantilevered portions on one or more of the sides, and the fifth side providing the interconnection side. In a representative embodiment, the shape of the first electrode **102** is substantially identical to the shape of the second electrode **104**. Notably, the first electrode **102** may comprise a larger area than the second electrode **104**, and the shape of the first electrode **102** may be different than the shape of the second electrode **104**.

The fundamental mode of the acoustic resonator **100** is the longitudinal extension mode or "piston" mode. This mode is excited by the application of a time-varying voltage to the two electrodes at the resonant frequency of the acoustic resonator **100**. The piezoelectric material converts

energy in the form of electrical energy into mechanical energy. In an ideal FBAR having infinitesimally thin electrodes, resonance occurs when the applied frequency is equal to the velocity of sound of the piezoelectric medium divided by twice the thickness of the piezoelectric medium:  $f=v_{ac}/(2*T)$ , where  $T$  is the thickness of the piezoelectric medium and  $v_{ac}$  is the acoustic phase velocity. For resonators with finite thickness electrodes, this equation is modified by the weighted acoustic velocities and thicknesses of the electrodes.

A quantitative and qualitative understanding of the  $Q$  of a resonator may be obtained by plotting on a Smith Chart the ratio of the reflected energy to applied energy as the frequency is varied for the case in which one electrode is connected to ground and another to signal, for an FBAR resonator with an impedance equal to the system impedance at the resonant frequency. As the frequency of the applied energy is increased, the magnitude/phase of the FBAR resonator sweeps out a circle on the Smith Chart. This is referred to as the  $Q$ -circle. Where the  $Q$ -circle first crosses the real axes (horizontal axes), this corresponds to the series resonance frequency  $f_s$ . The real impedance (as measured in Ohms) is  $R_s$ . As the  $Q$ -circle continues around the perimeter of the Smith chart, it again crosses the real axes. The second point at which the  $Q$  circle crosses the real axis is labeled  $f_p$ , the parallel or anti-resonant frequency of the FBAR. The real impedance at  $f_p$  is  $R_p$ .

Often it is desirable to minimize  $R_s$  while maximizing  $R_p$ . Qualitatively, the closer the  $Q$ -circle "hugs" the outer rim of the Smith chart, the higher the  $Q$ -factor of the device. The  $Q$ -circle of an ideal lossless resonator would have a radius of one and would be at the edge of the Smith chart. However, as noted above, there are energy losses that impact the  $Q$ -factor of the device. For instance, and in addition to the sources of acoustic losses mentioned above, Rayleigh-Lamb (lateral or spurious) modes are in the  $x,y$  dimensions of the piezoelectric layer **103**. These lateral modes are due to interfacial mode conversion of the longitudinal mode traveling in the  $z$ -direction; and due to the creation of non-zero propagation vectors,  $k_x$  and  $k_y$ , for both the TE mode and the various lateral modes (e.g., the  $S_0$  (symmetric) mode and the zeroth and (asymmetric) modes,  $A_0$  and  $A_1$ ), which are due to the difference in effective velocities between the regions where electrodes are disposed and the surrounding regions of the resonator where there are no electrodes. At a specific frequency, the acoustic wave length of an acoustic resonator is determined by  $v/f$ , where  $v$  is acoustic velocity and  $f$  is frequency. It is believed that periodicity of  $Q_p$  (i.e., the position of maxima and minima as a function of the width of the cantilevered portion **106**) is related to the acoustic wave length. At a maxima of  $Q_p$ , the vibration of the wing **106** is comparatively far from its mechanical resonance; while at a minima mechanical resonance of the cantilevered portion **106** occurs. This phenomenon can be appreciated from a review of FIG. **2A** below, for example: as frequency decreases, acoustic wave length increases, and the width of the cantilevered portion **106** at a maxima increases accordingly.

Regardless of their source, the lateral modes are parasitic in many resonator applications. For example, the parasitic lateral modes couple at the perimeter of the resonator and remove energy available for the longitudinal modes and thereby reduce the  $Q$ -factor of the resonator device. Notably, as a result of parasitic lateral modes and other acoustic losses sharp reductions in  $Q$  can be observed on a  $Q$ -circle of the Smith Chart of the  $S_{11}$  parameter. These sharp reductions in

Q-factor are known as “rattles” or “loop-de-loops,” which are shown and described below.

The cantilevered portion(s) **106** of the representative embodiments provide a change in the acoustic impedance at the boundary of the active area **110** of the acoustic resonator **100**. As a result, reflections of lateral modes at the boundary are promoted. In a representative embodiment, the boundary of the active area **110** of the acoustic resonator and the cantilevered portion **106** is solid (electrodes and piezoelectric layer) and air, which presents a comparatively large impedance mismatch and a comparatively high reflection coefficient. As a result, lateral modes are comparatively highly reflected, which improves the Q-factor by two mechanisms. First, because the reflected lateral modes are not transmitted, their energy is not lost. Improving the losses by reducing transmission of lateral modes outside the active area **110** of the acoustic resonator **100** can increase the Q-factor of the acoustic resonator **100**. Second, a portion of the reflected lateral modes is converted into desired longitudinal modes. The greater the wave energy is in longitudinal modes, the higher the Q-factor. As a result, the cantilevered portion(s) **106** of the acoustic resonator **100** enhances the Q-factor of both the parallel and the series resonance (i.e.,  $Q_p$  and  $Q_s$ ).

FIG. 1C is a cross-sectional view of acoustic resonator **100'** in accordance with a representative embodiment. The acoustic resonator **100'** comprises substrate **101**, first electrode **102** disposed beneath a piezoelectric layer **103**, which comprises a first surface in contact with a first electrode **102** and a second surface in contact with second electrode **104**. Optional passivation layer **105** is provided over the second electrode **104**. Cantilevered portion **106** of the second electrode **104** is provided on at least one side of the second electrode **104**. As noted above, the cantilevered portion **106** may also be referred to as a ‘wing.’

As noted above acoustic resonator **100'** may be fabricated according to known semiconductor processing methods and using known materials. Illustratively, the acoustic resonator **100'** may be fabricated according to the teachings of commonly owned U.S. Pat. Nos. 5,587,620; 5,873,153; 6,384,697; 6,507,983; and 7,275,292 to Ruby, et al.; and U.S. Pat. No. 6,828,713 to Bradley, et al.

When connected in a selected topology, a plurality of acoustic resonators **100'** can act as an electrical filter. Again, by way of example, the acoustic resonators **100'** may be arranged in a ladder-filter arrangement, such as described in U.S. Pat. No. 5,910,756 to Ella, and U.S. Pat. No. 6,262,637 to Bradley, et al. The electrical filters may be used in a number of applications, such as in duplexers.

The first and second electrodes **102**, **104** each comprise an electrically conductive material (e.g., molybdenum (Mo)) and provide an oscillating electric field in the y-direction of the coordinate system shown (i.e., the direction of the thickness of the substrate **101**). In the illustrative embodiment described presently, the y-axis is the axis for the TE (longitudinal) mode(s) for the resonator. In a representative embodiment, the piezoelectric layer **103** and first and second electrodes **102**, **104** are suspended over an acoustic mirror **107'**, such as a mismatched acoustic Bragg reflector formed in or on the substrate **101**. FBARs provided over an acoustic mirror are sometimes referred to as solid mount resonators (SMRs) and, for example, may be as described in above-referenced U.S. Pat. No. 6,107,721 to Lakin. Accordingly, the acoustic resonator **100'** is a mechanical resonator, which can be electrically coupled via the piezoelectric layer **103**.

The cantilevered portion **106** of the second electrode **104** extends over gap **108**, which illustratively comprises air. As

noted above, in a representative embodiment, a sacrificial layer (not shown) is deposited by known technique over the first electrode **102** and a portion of the piezoelectric layer **103**. The second electrode **104** and passivation layer **105** are provided over the sacrificial layer. Again, by way of illustration, the sacrificial material comprises phosphosilicate glass (PSG), which illustratively comprises 8% phosphorous and 92% silicon dioxide. After the formation of the second electrode **104** and passivation layer **105**, the sacrificial layer is etched away illustratively with hydrofluoric acid leaving the cantilevered portion **106**.

As noted above, rather than air, the gap **108** may comprise other materials including low acoustic impedance materials, such as carbon (C) doped  $\text{SiO}_2$ , which is also referred as Black-diamond; or dielectric resin commercially known as SiLK™; or benzocyclobutene (BCB). Such low acoustic impedance materials may be provided in the gap **108** by known methods. The low acoustic impedance material may be provided after removal of sacrificial material used to form the gap **108**, or may be used instead of the sacrificial material in the gap **108**, and not removed.

The region of contacting overlap of the first and second electrodes **102**, **104**, the piezoelectric layer **103** and the acoustic mirror **107'** is referred to as the active area **110** of the acoustic resonator **100'**. By contrast, the inactive area of the acoustic resonator **100'** comprises a region of overlap between first electrode **102** or second electrode **104**, or both, and the piezoelectric layer **103** not disposed over the acoustic mirror **107'**. As described more fully in the parent application, it is beneficial to the performance of the acoustic resonator **100'** to reduce the area of the inactive region of the acoustic resonator **100'** to the extent practical.

The cantilevered portion **106** extends beyond an edge of the active area **110** by a width **109** as shown. Electrical contact **111** is connected to a signal line (not shown) and electronic components (not shown) selected for the particular application of the acoustic resonator **100'**. This portion of the acoustic resonator **100'** comprises an interconnection side **112** of the acoustic resonator **100'**. As will become clearer as the present description continues, the interconnection side **112** of the second electrode **104** to which the electrical contact **111** is made does not comprise a cantilevered portion **106**. By contrast, one or more non-connecting sides of the acoustic resonator **100'** may comprise cantilevered portions **106** that extend beyond the edge of the active area **110**.

FIG. 2A shows a graph **200** of the Q-factor at parallel resonance ( $Q_p$ ) versus width (e.g., width **109**, also referred to as “wing width”) of the cantilevered portion(s) **106** (“wings”) of an acoustic resonator in accordance with a representative embodiment. The graph **200** provides data of an acoustic resonator comprising three cantilevered portions **106**, such as illustratively shown in FIGS. 1A and 1B. The Q-factor is dependent on the width of the cantilevered portion **106** for a given parallel resonance frequency. As shown, there are relative maxima in  $Q_p$  at points **201**, **202** and **203**; and local minima at points **204**, **205** and **206** as the width **109** increases. Notably,  $Q_p$  improves significantly at a certain width **109**, compared with width **109** of the cantilevered portion **106** being zero, which is equivalent to an acoustic resonator having substantially the same structure as acoustic resonator **100** but not comprising the cantilevered portion **106**.

Improvements in  $Q_p$  due to the inclusion of the cantilevered portion **106** results from different boundary conditions at the edge of the active area **110** of the acoustic resonator **100** compared to an acoustic resonator not comprising a

cantilevered portion(s). As described above, the cantilevered portion **106** at the edge of active area **110** of the acoustic resonator will reflect certain acoustic modes due to the impedance mismatch at the boundary of the cantilevered portion **106** and the active area **110**, resulting in improved Q. It is believed that the local minima may result from the excitation of a mechanical resonance of the cantilevered portion **106**, which results in losses. The excited resonance conditions at relative minima **204**, **205**, **206**, result in energy not reflected back into the active area **110** of the acoustic resonator **100**, losses and reduced Q. Accordingly, when designing acoustic resonator **100**, the width **109** of the cantilevered portion **106** is beneficially selected at a relative maximum **201**, **202**, **203**, and not at a relative minimum **204**, **205**, **206**.

FIG. 2B shows a graph **207** of the Q-factor at series resonance ( $Q_s$ ) versus width (e.g., width **109** ('wing width')) of the cantilevered portion **106** ('wing') of an acoustic resonator in accordance with a representative embodiment. The graph **207** provides data of an acoustic resonator comprising three cantilevered portions **106**, such as illustratively shown in FIGS. 1A and 1B. The Q-factor is dependent on the width of the cantilevered portion **106** for a given series resonance frequency. As shown, there are relative maxima in  $Q_s$  at points **208**, **209** and **210**; and local minima at points **211**, **212** and **213** as the width **109** increases. Notably,  $Q_s$  improves significantly at a certain width **109**, compared with width=0 of the cantilevered portion **106**, which is equivalent to an acoustic resonator having substantially the same configuration as acoustic resonator **100** but without cantilevered portions **106**.

As described above, the cantilevered portion **106** at the edge of active area **110** of the acoustic resonator will reflect certain acoustic modes due to the impedance mismatch at the boundary of the cantilevered portion **106** and the active area **110**, resulting in improved Q. It is believed that the local minima may result from the excitation of a mechanical resonance of the cantilevered portion **106**, which results in losses. The excited resonance conditions at relative minima **211**, **212** and **213** result in energy not reflected back into the active area **110** of the acoustic resonator **100**, losses and, therefore, reduced Q. Accordingly, when designing acoustic resonator **100**, the width **109** of the cantilevered portion **106** is beneficially selected at a relative maximum **208,209** or **210**, and not at a relative minimum **211**, **212** or **213**.

Moreover, because the cantilevered portion **106** does not generate spurious lateral modes, there is no attendant degradation in Q near the series resonance frequency as can occur with the inclusion of known raised frame elements (sometimes referred to as 'outies') and known recessed frame elements (sometimes referred to as 'innies'.) Notably, both raised frame elements and recessed frame elements may be disposed annularly about acoustic resonator and are sometimes referred to as annular recesses and annular frames. The raised frame elements and recessed frame elements may generate spurious modes, but recessed frame elements improve the coupling coefficient ( $k_r^2$ ), and raised frame elements may slightly decrease  $k_r^2$ . Furthermore the cantilevered portion **106** does not generate spurious modes because its location is not within the active area **110**. The cantilevered portion **106** also does not degrade  $k_r^2$  as significantly as the raised and recessed frame elements. As can be appreciated from a review of FIG. 2A,  $k_r^2$  at peak Q corresponds to a width of the cantilevered portion **106** of approximately  $4.75 \mu\text{m}$  is approximately 5.2. This represents an increase in  $k_r^2$  of approximately 10% greater than that of a known acoustic resonator with a raised frame element.

FIG. 3A shows a cross-sectional view of an acoustic resonator **300** in accordance with a representative embodiment. Many of the features of the acoustic resonator **300** are common to those of acoustic resonator **100** described in connection with representative embodiments in FIGS. 1A-1B. The details of common features, characteristics and benefits thereof are not repeated in order to avoid obscuring the presently described embodiments.

The acoustic resonator **300** comprises a bridge **301** along the interconnection side **112**. The bridge **301** provides a gap **302**, which may be a void (e.g., air) or may be filled with a low acoustic impedance material. The bridge **301** is described in the parent application (now U.S. Pat. No. 8,248,185), and as such many of the details of the bridge **301** are not repeated in the present application to avoid obscuring the description of the representative embodiments of the acoustic resonator **300**. As depicted in FIG. 3A, the cavity **107** has an edge **303**, and the bridge **301** extends past the edge **303** of the cavity **107** (or similar reflective element, such as a mismatched Bragg reflector) and over the substrate **101**. As such, in a representative embodiment, the bridge **301** is disposed partially over the cavity **107**, extends over the edge **303** of the cavity **107**, and is disposed partially over the substrate **101**.

As depicted in FIG. 3A, the second electrode **104** comprises the first surface **104'** disposed substantially at the first height (y-dimension in the coordinate system depicted). The bridge **301** comprises a third surface **301'**. The third surface **301'** is disposed substantially at a third height (again, y-dimension in the coordinate system depicted). The third height is higher than the first height. Thus, the third surface **301'** is raised up relative to the first surface **104'**.

As described above, the cantilevered portion **106** provides an improvement in the Q-factor. Similarly, the bridge **301** also provides an improvement in the Q-factor. Beneficially, the combination of the cantilevered portion **106** and the bridge **301** provides a further improvement in the Q-factor of the acoustic resonator **300**. To this end, inclusion of the bridge **301** with the cantilevered portion **106** in the acoustic resonator **300** results in an improvement in the Q-factor at parallel resonance ( $Q_p$ ) and some impact on the Q-factor at series resonance ( $Q_s$ ). This is somewhat expected since the bridge **301** predominantly impacts  $Q_p$ , as described in the parent application.

FIG. 3B shows a cross-sectional view of an acoustic resonator **300'** in accordance with a representative embodiment. Many of the features of the acoustic resonator **300'** are common to those of acoustic resonator **100'**, **300** described in connection with representative embodiments in FIGS. 1C and 3A. The details of common features, characteristics and benefits thereof are not repeated in order to avoid obscuring the presently described embodiments.

The acoustic resonator **300'** comprises bridge **301** along the interconnection side **112**. The bridge **301** provides a gap **302**, which may be a void (e.g., air) or may be filled with a low acoustic impedance material. The bridge **301** is described in the parent application (now U.S. Pat. No. 8,248,185), and as such many of the details of the bridge **301** are not repeated in the present application to avoid obscuring the description of the representative embodiments of the acoustic resonator **300**. As depicted in FIG. 3B, the acoustic mirror **107'** has an edge **303'**, and the bridge **301** extends past the edge **303'** of the acoustic mirror **107'** and over the substrate **101**. As such, in a representative embodiment, the bridge **301** is disposed partially over the acoustic mirror **107'**, extends over the edge **303'** of the acoustic mirror **107'**, and is disposed partially over the substrate **101**.

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As described above, the cantilevered portion **106** provides an improvement in the Q-factor. Similarly, the bridge **301** also provides an improvement in the Q-factor. Beneficially, the combination of the cantilevered portion **106** and the bridge **301** provides a further improvement in the Q-factor of the acoustic resonator **300'**. To this end, inclusion of the bridge **301** with the cantilevered portion **106** in the acoustic resonator **300'** results in an improvement in the Q-factor at parallel resonance ( $Q_p$ ) and some impact on the Q-factor at series resonance ( $Q_s$ ). This is somewhat expected since the bridge **301** predominantly impacts  $Q_p$ , as described in the parent application.

FIG. **4A** shows a graph **400** of the Q-factor at parallel resonance ( $Q_p$ ) versus width (e.g., width **109**, ('wing width')) of the cantilevered portion **106** of an acoustic resonator comprising a bridge (e.g., acoustic resonator **300**) in accordance with a representative embodiment. The graph **400** provides data of an acoustic resonator comprising three cantilevered portions **106**, such as illustratively shown in FIGS. **1A** and **1B**. The Q-factor is dependent on the wing width for a given parallel resonance frequency. As shown, there are relative maxima in  $Q_p$  at points **401**, **402** and **403**; and relative minima at points **404** and **405** as the width **109** increases. Notably,  $Q_p$  improves significantly at a certain width **109**, compared with width=0 of the cantilevered portion **106**, which is equivalent to an acoustic resonator having substantially the same configuration shown in FIG. **3** but without cantilevered portions **106**.

The synergistic impact of the combination of the bridge **301** and the cantilevered portions **106** on  $Q_p$  can be appreciated by a comparison of data in FIGS. **2A** and **4A**. For example, in an embodiment comprising cantilevered portion **106** having a width (e.g., width **109**) of approximately 2.5  $\mu\text{m}$ ,  $Q_p$  in FIG. **2A** (near point **201**, for example) is approximately 850. By contrast, in an embodiment comprising bridge **301** and cantilevered portion **106** having a width of approximately 2.5  $\mu\text{m}$  (e.g., near point **406**) provides  $Q_p$  of approximately 1500. Similarly, in an embodiment comprising cantilevered portion **106** having a width (e.g., width **109**) of approximately 3.0  $\mu\text{m}$ ,  $Q_p$  in FIG. **2A** (near point **202**, for example) is approximately 975. By contrast, in an embodiment comprising bridge **301** and cantilevered portion **106** having a width of approximately 3.0  $\mu\text{m}$  provides  $Q_p$  of approximately 1750 (e.g., point **402** in FIG. **4A**).

FIG. **4B** shows a graph **407** of the Q-factor at series resonance ( $Q_s$ ) versus width (e.g., width **109**) of the cantilevered portion **106** of an acoustic resonator comprising a bridge (e.g., acoustic resonator **300**) in accordance with a representative embodiment. The graph **407** provides data of an acoustic resonator comprising three cantilevered portions **106**, such as illustratively shown in FIGS. **1A** and **1B**. The Q-factor is dependent on the wing width for a given series resonance frequency. As shown, there are relative maxima in  $Q_p$  at points **408**, **409** and **410**; and relative minima at points **411**, **412**, **413** and **414** as the width **109** increases. Notably,  $Q_s$  improves significantly at a certain width **109**, compared with width=0 of the cantilevered portion **106**, which is equivalent to an acoustic resonator having substantially the same configuration shown in FIG. **3** but without cantilevered portions **106**. As note previously, the impact of the bridge **301** on improved  $Q_s$  is less dramatic than its impact on  $Q_p$ .

FIG. **4C** shows a graph of the Q-factor at parallel resonance ( $Q_p$ ) versus width of the cantilevered portion(s) of an acoustic resonator in accordance with a representative embodiment. As the total thickness of the acoustic stack decreases, the resonance frequency increases and, therefore, the acoustic wavelength at the resonance frequency

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decreases. An optimum width **109** ('wing width') of the cantilevered portion **106**, at which the most Q enhancement is achieved, is determined by resonance acoustic quarter-wavelength, therefore smaller optimum wing width is required to achieve optimum Q. Notably, FIG. **4C** relates to an acoustic resonator having a parallel resonance of 800 MHz. A maximum Q-value (shown at point **415**) is attained at a wing width of approximately 1.6  $\mu\text{m}$ .

FIG. **5A** shows a cross-sectional view of an acoustic resonator **500** taken along line **5B-5B** in accordance with a representative embodiment. FIG. **5B** shows a top view of the acoustic resonator **500**. Many of the features of the acoustic resonator **500** are common to those of acoustic resonators **100**, **300** described in connection with representative embodiments in FIGS. **1A-1B** and **3**. The details of common features, characteristics and benefits thereof are not repeated in order to avoid obscuring the presently described embodiments.

The acoustic resonator **500** comprises the bridge **301** along the interconnection side **112**. The bridge **301** provides the gap **302**, which may be a void (e.g., air) or may be filled with a low acoustic impedance material. In addition to the bridge **301**, the acoustic resonator **500** comprises a raised frame element **501** (commonly referred to as an 'outie'). The raised frame element **501** may be provided over one or more sides of the acoustic resonator **500** and provides an acoustic mismatch at the boundary of the second electrode **104**, thereby improving signal reflections at the boundary and reducing acoustic losses. Ultimately, reduced losses translate into an improved Q-factor of the device. While the raised frame element **501** are shown disposed over the second electrode **104**, these features may instead be provided over the first electrode **102** and beneath the piezoelectric layer **103**, or selectively on both the first and second electrodes **102,104**. Further details of the use, formation and benefits of the raised frame element **501** may be found for example, in commonly owned U.S. Pat. No. 7,280,007 entitled "Thin Film Bulk Acoustic Resonator with a Mass Loaded Perimeter" to Feng, et al.; and commonly owned U.S. Patent Application Publication 20070205850 entitled "Piezoelectric Resonator Structure and Electronic Filters having Frame Elements" to Jamneala, et al. The disclosures of this patent and patent application publication are specifically incorporated herein by reference.

The raised frame element **501** results in an increase in the parallel impedance ( $R_p$ ) but generates spurious modes below the series resonance frequency; whereas the cantilevered portion **106** increases  $R_p$  without degrading  $Q_s$ . This is because the area of the raised frame element **501** represents a comparatively small fraction of the active area of the acoustic resonator **500**. It can be shown that this is equivalent to an acoustic resonator connected in parallel to an acoustic resonator comprising a frame element. Since the resonance frequency of an acoustic resonator comprising the raised frame element **501** is lower, spurious modes are generated below  $f_s$  of the acoustic resonator without the frame element. The addition of the cantilevered portion **106** to the acoustic resonator **500** comprising the raised frame element **501** further increases  $R_p$  without resulting in additional spurious modes below  $f_s$  because the wing **106** lies outside of the active area **110** of the acoustic resonator **500**.

FIG. **6** shows a cross-sectional view of an acoustic resonator **600** in accordance with a representative embodiment. Many of the features of the acoustic resonator **600** are common to those of acoustic resonators **100**, **300**, **500** described in connection with representative embodiments in FIGS. **1A-1B**, **3**, **5A** and **5B**. The details of common

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features, characteristics and benefits thereof are not repeated in order to avoid obscuring the presently described embodiments.

The acoustic resonator **600** comprises the bridge **301** along the interconnection side **112**. The bridge **301** provides the gap **302**, which may be a void (e.g., air) or may be filled with a low acoustic impedance material. In addition to the bridge **301**, the acoustic resonator **600** comprises a recessed frame element **601** ('innie'). The recessed frame element **601** may be disposed along one or more sides of the acoustic resonator **600** and provides an acoustic mismatch at the perimeter of the second electrode **104**, thereby improving signal reflections and reducing acoustic losses. Ultimately, reduced losses translate into an improved Q-factor of the device. While the recessed frame element **601** is shown disposed over the second electrode **104**, the recessed frame element **601** may instead be provided over the first electrode **102** and beneath the piezoelectric layer **103**, or selectively on both the first and second electrodes **102,104**. Further details of the use, formation and benefits of the recessed frame element **601** may be found for example, in commonly owned U.S. Pat. No. 7,280,007 entitled "Thin Film Bulk Acoustic Resonator with a Mass Loaded Perimeter" to Feng, et al.; and commonly owned U.S. Patent Application Publication 20070205850 entitled "Piezoelectric Resonator Structure and Electronic Filters having Frame Elements" to Jamneala, et al. The disclosures of this patent and patent application publication are specifically incorporated herein by reference. Moreover, the incorporation of both a raised frame element (e.g., raised frame element **501**) and a recessed frame (e.g., recessed frame element **601**) in an acoustic resonator **100, 300, 500, 600** is also contemplated by the present teachings. The incorporation of both raised and recessed frame elements in an acoustic resonator is disclosed in the parent application (U.S. patent application Ser. No. 12/490,525).

When connected in a selected topology, a plurality of acoustic resonators **100, 300, 500, 600** can function as an electrical filter. FIG. 7 shows a simplified schematic block diagram of an electrical filter **700** in accordance with a representative embodiment. The electrical filter **700** comprises series acoustic resonators **701** and shunt acoustic resonators **702**. The series acoustic resonators **701** and shunt acoustic resonators **702** may comprise the acoustic resonators **100, 300, 500, 600** described in connection with the representative embodiments of FIGS. **1A, 1B, 3, 5A, 5B** and **6**. The electrical filter **700** is commonly referred to as a ladder filter, and may be used for example in duplexer applications. Further details of a ladder-filter arrangement may be as described for example in U.S. Pat. No. 5,910,756 to Ella, and U.S. Pat. No. 6,262,637 to Bradley, et al. The disclosures of these patents are specifically incorporated by reference. It is emphasized that the topology of the electrical filter **700** is merely illustrative and other topologies are contemplated. Moreover, the acoustic resonators of the representative embodiments are contemplated in a variety of applications besides duplexers.

In accordance with illustrative embodiments, acoustic resonators for various applications such as in electrical filters are described having an electrode comprising a cantilevered portion. Additionally, acoustic resonators for various applications such as in electrical filters are described having an electrode comprising a cantilevered portion and a bridge. One of ordinary skill in the art appreciates that many variations that are in accordance with the present teachings are possible and remain within the scope of the appended claims. These and other variations would become clear to

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one of ordinary skill in the art after inspection of the specification, drawings and claims herein. The invention therefore is not to be restricted except within the spirit and scope of the appended claims.

We claim:

1. An acoustic resonator, comprising:

a first electrode;

a second electrode comprising a plurality of sides, wherein at least one of the sides comprises a cantilevered portion, wherein the second electrode comprises a first surface disposed substantially at a first height, and the cantilevered portion comprises a second surface disposed substantially at a second height, which is higher than the first height;

a piezoelectric layer disposed between the first and second electrodes, the cantilevered portion extending above the piezoelectric layer, wherein a first gap exists between the cantilevered portion and the piezoelectric layer, and the first gap is substantially filled with a low acoustic impedance material; and

a bridge comprising a second gap, which exists in a region between the second electrode and the piezoelectric layer, wherein the second gap is substantially filled with the low acoustic impedance material, and is disposed adjacent to one of the sides of the second electrode.

2. The acoustic resonator as claimed in claim 1, further comprising a reflective element disposed beneath the first electrode, the second electrode and the piezoelectric layer, wherein a contacting overlap of the reflective element, the first electrode, the second electrode and the piezoelectric layer comprises an active area of the acoustic resonator, and the bridge is disposed adjacent to the active area of the acoustic resonator.

3. The acoustic resonator as claimed in claim 2, wherein the cantilevered portion of the second electrode extends beyond a termination of the active area.

4. The acoustic resonator as claimed in claim 1, wherein all but one of the plurality of sides of the second electrode comprises the cantilevered portion.

5. The acoustic resonator as claimed in claim 4, further comprising an electrical connection to the one of the plurality of sides of the second electrode that does not comprise the cantilevered portion.

6. An acoustic resonator, comprising:

a first electrode;

a second electrode comprising a plurality of sides, wherein at least one of the sides comprises a cantilevered portion, wherein the second electrode comprises a first surface disposed substantially at a first height, and the cantilevered portion comprises a second surface disposed substantially at a second height, which is higher than the first height;

a piezoelectric layer disposed between the first and second electrodes, the cantilevered portion extending above the piezoelectric layer, wherein a first gap exists between the cantilevered portion and the piezoelectric layer, and the first gap is substantially filled with a low acoustic impedance material;

a bridge comprising a second gap in a region between the second electrode and the piezoelectric layer, wherein the second gap is substantially filled with the low acoustic impedance material, and is disposed adjacent to one of the sides of the second electrode;

a reflective element disposed beneath the first electrode, the second electrode and the piezoelectric layer, wherein a contacting overlap of the reflective element,

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the first electrode, the second electrode and the piezoelectric layer comprises an active area of the acoustic resonator, and the bridge is disposed adjacent to the active area of the acoustic resonator; and

a frame element.

7. The acoustic resonator as claimed in claim 6, wherein the frame element is a recessed frame element.

8. The acoustic resonator claimed in claim 6, wherein the frame element comprises a raised frame element.

9. The acoustic resonator claimed in claim 6, wherein the low acoustic impedance material is one of carbon (C) doped silicon dioxide (SiO<sub>2</sub>), SiLK™ dielectric resin, or benzocyclobutene (BCB).

10. The acoustic resonator as claimed in claim 6, further comprising:

a reflective element beneath the first electrode, the second electrode and the piezoelectric layer, wherein a contacting overlap of the reflective element, the first electrode, the second electrode and the piezoelectric layer comprises an active area of the acoustic resonator, and the bridge is disposed adjacent to the active area of the acoustic resonator.

11. The acoustic resonator as claimed in claim 10, wherein the cantilevered portion of the second electrode extends beyond a termination of the active area.

12. The acoustic resonator as claimed in claim 6, wherein all but one of the plurality of sides of the second electrode comprises the cantilevered portion.

13. The acoustic resonator as claimed in claim 12, further comprising an electrical connection to the one of the plurality of sides of the second electrode that does not comprise the cantilevered portion.

14. An acoustic resonator, comprising:

a first electrode;

a second electrode comprising a plurality of sides, wherein at least one of the sides comprises a cantilevered portion, wherein the second electrode comprises a first surface disposed substantially at a first height, and the cantilevered portion comprises a second surface

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disposed substantially at a second height, which is higher than the first height;

a piezoelectric layer disposed between the first and second electrodes, the cantilevered portion extending above the piezoelectric layer, wherein a first gap exists between the cantilevered portion and the piezoelectric layer, and the first gap is substantially filled with a low acoustic impedance material; and

a bridge comprising a second gap in a region between the second electrode and the piezoelectric layer, wherein the second gap is substantially filled with the low acoustic impedance material, and is disposed adjacent to one of the sides of the second electrode,

wherein the low acoustic impedance material is one of carbon (C) doped silicon dioxide (SiO<sub>2</sub>), SiLK™ dielectric resin, or benzocyclobutene (BCB).

15. The acoustic resonator as claimed in claim 14, further comprising:

a reflective element beneath the first electrode, the second electrode and the piezoelectric layer, wherein a contacting overlap of the reflective element, the first electrode, the second electrode and the piezoelectric layer comprises an active area of the acoustic resonator, and the bridge is disposed adjacent to the active area of the acoustic resonator.

16. The acoustic resonator as claimed in claim 15, wherein the cantilevered portion of the second electrode extends beyond a termination of the active area.

17. The acoustic resonator as claimed in claim 14, further comprising a recessed frame element.

18. The acoustic resonator claimed in claim 14, further comprising a raised frame element.

19. The acoustic resonator as claimed in claim 14, wherein all but one of the plurality of sides of the second electrode comprises the cantilevered portion.

20. The acoustic resonator as claimed in claim 19, further comprising an electrical connection to the one of the plurality of sides of the second electrode that does not comprise the cantilevered portion.

\* \* \* \* \*



UNITED STATES PATENT AND TRADEMARK OFFICE  
**CERTIFICATE OF CORRECTION**

PATENT NO. : 10,461,719 B2  
APPLICATION NO. : 15/371920  
DATED : October 29, 2019  
INVENTOR(S) : John Choy, Chris Feng and Phil Nikkel

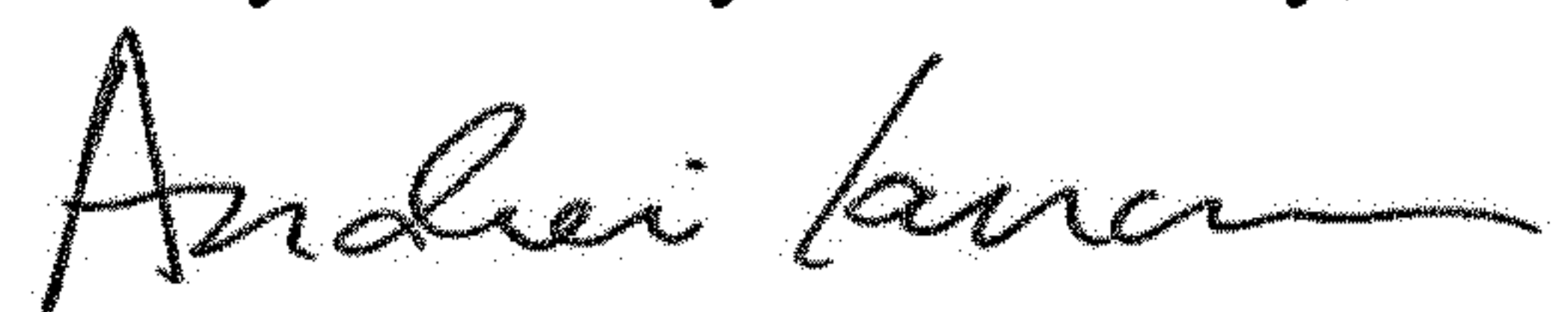
Page 1 of 1

It is certified that error appears in the above-identified patent and that said Letters Patent is hereby corrected as shown below:

On the Title Page

Item (73), REPLACE “Avago Technologies General IP (Singapore) Pte. Ltd.” with “Avago Technologies International Sales Pte. Limited”

Signed and Sealed this  
Twenty-fifth Day of February, 2020



Andrei Iancu  
*Director of the United States Patent and Trademark Office*